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Attorney Docket No. 061063-0318214  
Client Reference: OSP-18831

**PATENT****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: YOSHINOBU NAKADA, HIROYUKI SHIRAKI and TAKESHI HASEGAWA

Application No.: TBD  
Filed: September 30, 2005

Confirmation No: Unknown  
Group No.:  
Examiner Unknown

For: HEAT TREATMENT JIG AND HEAT TREATMENT METHOD FOR SILICON WAFER

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**APPLICATION DATA SHEET**  
**37 C.F.R. § 1.76**

**BIBLIOGRAPHIC DATA****1. Applicant information**

First applicant: YOSHINOBU NAKADA  
Citizenship: Japan  
Residence: Ageo-shi, Japan

Second applicant: HIROYUKI SHIRAKI  
Citizenship: Japan  
Residence: Ichikawa-shi, Japan

Third applicant: TAKESHI HASEGAWA  
Citizenship: Japan  
Residence: Yonezawa-shi, Japan

**2. Correspondence information**

Correspondence for this application should be addressed as follows:

Customer No.: 00909

**3. Application information**

Title of Invention: HEAT TREATMENT JIG AND HEAT TREATMENT METHOD FOR SILICON WAFER

Docket number assigned to this application: 061063-0318214

Suggested Classification: Class:  
Subclass:  
Technology Center to which subject matter is assigned:

Attorney Docket No. 061063-0318214  
Client Reference: OSP-18831

**PATENT**

Total number of drawing sheets: Figure 7

Type of application: Utility

Application is to be published. Suggested drawing figure for publication: Figure 1

Secrecy order under § 5.2:

This application does not disclose subject matter of an application which is under a secrecy order pursuant to § 5.2.

**4. Representative information**

The following have a power of attorney or authorization of agent in this application:

Customer No.: 00909

**5. Domestic Priority information**

Domestic priority for this application is claimed as follows:

35 U.S.C. § 365(c):

Application No.: PCT/JP2004/004508

Filed: March 30, 2004

**6. Foreign priority information**

Foreign priority is claimed for this application as follows:

Country: Japan

Application No.: 2003-097365

Filing Date: March 31, 2003

**7. Assignee information**

The assignee(s) of this application is/are:

SUMCO CORPORATION

2-1, Shibaura 1-chome, Minato-ku

Tokyo

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Extent of interest of assignee in application: ENTIRE RIGHTS, TITLE AND INTEREST

Date: September 30, 2005



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